

OPA244
OPA2244
OPA4244

MicroPower, Single-Supply OPERATIONAL AMPLIFIERS MicroAmplifier™ Series

FEATURES

- **MicroSIZE PACKAGES**
 OPA244 (Single): SOT-23-5
 OPA2244 (Dual): MSOP-8
 OPA4244 (Quad): TSSOP-14
- **MicroPOWER:** $I_Q = 50\mu\text{A}/\text{channel}$
- **SINGLE SUPPLY OPERATION**
- **WIDE BANDWIDTH:** 430kHz
- **WIDE SUPPLY RANGE:**
 Single Supply: 2.2V to 36V
 Dual Supply: $\pm 1.1\text{V}$ to $\pm 18\text{V}$

APPLICATIONS

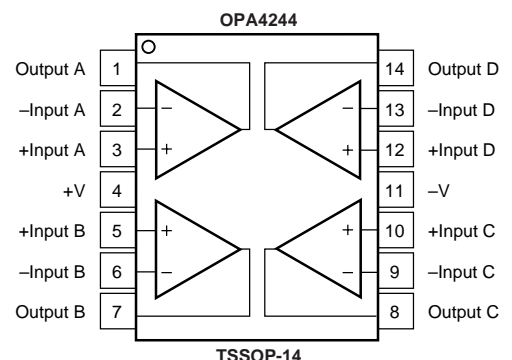
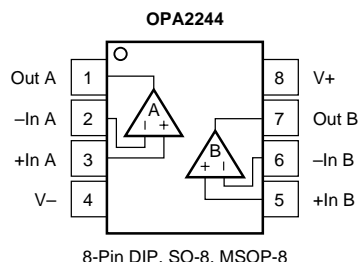
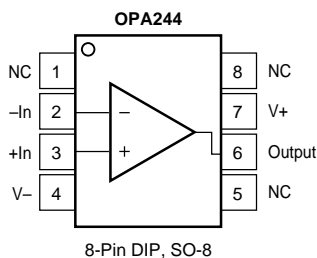
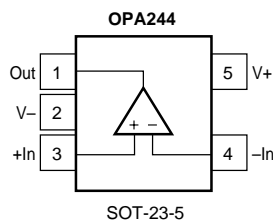
- **BATTERY POWERED SYSTEMS**
- **PORTABLE EQUIPMENT**
- **PCMCIA CARDS**
- **BATTERY PACKS AND POWER SUPPLIES**
- **CONSUMER PRODUCTS**

DESCRIPTION

The OPA244 (single), OPA2244 (dual), and OPA4244 (quad) op amps are designed for very low quiescent current ($50\mu\text{A}/\text{channel}$), yet achieve excellent bandwidth. Ideal for battery powered and portable instrumentation, all versions are offered in micro packages for space-limited applications. The dual and quad versions feature completely independent circuitry for lowest crosstalk and freedom from interaction, even when overdriven or overloaded.

The OPA244 series is easy to use and free from phase inversion and overload problems found in some other op amps. These amplifiers are stable in unity gain and excellent performance is maintained as they swing to their specified limits. They can be operated from single (+2.2V to +36V) or dual supplies ($\pm 1.1\text{V}$ to $\pm 18\text{V}$). The input common-mode voltage range includes ground—ideal for many single supply applications. All versions have similar performance. However, there are some differences, such as common-mode rejection. All versions are interchangeable in most applications.

All versions are offered in miniature, surface-mount packages. OPA244 (single version) comes in the tiny 5-lead SOT-23-5 surface mount, SO-8 surface mount, and 8-pin DIP. OPA2244 (dual version) is available in the MSOP-8 surface mount, SO-8 surface-mount, and 8-pin DIP. The OPA4244 (quad) comes in the TSSOP-14 surface mount. They are fully specified from -40°C to $+85^\circ\text{C}$ and operate from -55°C to $+125^\circ\text{C}$. A SPICE Macromodel is available for design analysis.



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 Twx: 910-952-1111 • Internet: <http://www.burr-brown.com/> • Cable: BBRCORP • Telex: 066-6491 • FAX: (520) 889-1510 • Immediate Product Info: (800) 548-6132

SPECIFICATIONS: $V_S = +2.6V$ to $+36V$

Boldface limits apply over the specified temperature range, $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$

At $T_A = +25^\circ\text{C}$, $R_L = 20\text{k}\Omega$ connected to ground, unless otherwise noted.

PARAMETER	CONDITION	OPA244NA, PA, UA			UNITS
		MIN	TYP ⁽¹⁾	MAX	
OFFSET VOLTAGE Input Offset Voltage $T_A = -40^\circ\text{C}$ to 85°C vs Temperature vs Power Supply $T_A = -40^\circ\text{C}$ to 85°C	V_{OS} $V_S = \pm 7.5V$, $V_{CM} = 0$ dV_{OS}/dT $PSRR$ $T_A = -40^\circ\text{C}$ to 85°C $V_S = +2.6V$ to $+36V$ $V_S = +2.6V$ to $+36V$		± 0.7 ± 4 5	± 1.5 ± 2 50 50	mV mV $\mu\text{V}/^\circ\text{C}$ $\mu\text{V}/V$ $\mu\text{V}/V$
INPUT BIAS CURRENT Input Bias Current Input Offset Current	I_B I_{OS} $V_{CM} = V_S/2$ $V_{CM} = V_S/2$		-10 ± 1	-25 ± 10	nA nA
NOISE Input Voltage Noise, $f = 0.1\text{kHz}$ to 10kHz Input Voltage Noise Density, $f = 1\text{kHz}$ Current Noise Density, $f = 1\text{kHz}$	e_n i_n		0.4 22 40		$\mu\text{Vp-p}$ $\text{nV}/\sqrt{\text{Hz}}$ $\text{fA}/\sqrt{\text{Hz}}$
INPUT VOLTAGE RANGE Common-Mode Voltage Range Common-Mode Rejection $T_A = -40^\circ\text{C}$ to 85°C	V_{CM} CMRR $V_S = \pm 18V$, $V_{CM} = -18V$ to $+17.1V$ $V_S = \pm 18V$, $V_{CM} = -18V$ to $+17.1V$	0 84 84		$(V+) - 0.9$	V dB dB
INPUT IMPEDANCE Differential Common-Mode			$10^6 \parallel 2$ $10^9 \parallel 2$		$\Omega \parallel \text{pF}$ $\Omega \parallel \text{pF}$
OPEN-LOOP GAIN Open-Loop Voltage Gain $T_A = -40^\circ\text{C}$ to 85°C	A_{OL} $V_O = 0.5V$ to $(V+) - 0.9$ $V_O = 0.5V$ to $(V+) - 0.9$	86 86	106		dB dB
FREQUENCY RESPONSE Gain-Bandwidth Product Slew Rate Settling Time 0.01% Overload Recovery Time	GBW SR $G = 1$ 10V Step $V_{IN} \cdot \text{Gain} = V_S$		430 -0.1/+0.16 150 8		kHz $\text{V}/\mu\text{s}$ μs μs
OUTPUT Voltage Output, Positive $T_A = -40^\circ\text{C}$ to 85°C Voltage Output, Negative $T_A = -40^\circ\text{C}$ to 85°C Voltage Output, Positive $T_A = -40^\circ\text{C}$ to 85°C Voltage Output, Negative $T_A = -40^\circ\text{C}$ to 85°C Short-Circuit Current Capacitive Load Drive	V_O $A_{OL} \geq 80\text{dB}$, $R_L = 20\text{k}\Omega$ to $V_S/2$ $A_{OL} \geq 80\text{dB}$, $R_L = 20\text{k}\Omega$ to $V_S/2$ $A_{OL} \geq 80\text{dB}$, $R_L = 20\text{k}\Omega$ to $V_S/2$ $A_{OL} \geq 80\text{dB}$, $R_L = 20\text{k}\Omega$ to $V_S/2$ $A_{OL} \geq 80\text{dB}$, $R_L = 20\text{k}\Omega$ to Ground $A_{OL} \geq 80\text{dB}$, $R_L = 20\text{k}\Omega$ to Ground $A_{OL} \geq 80\text{dB}$, $R_L = 20\text{k}\Omega$ to Ground $A_{OL} \geq 80\text{dB}$, $R_L = 20\text{k}\Omega$ to Ground $A_{OL} \geq 80\text{dB}$, $R_L = 20\text{k}\Omega$ to Ground $A_{OL} \geq 80\text{dB}$, $R_L = 20\text{k}\Omega$ to Ground I_{SC} C_{LOAD}	$(V+) - 0.9$ $(V+) - 0.9$ 0.5 0.5 0.5 $(V+) - 0.75$ $(V+) - 0.75$ 0.1 0.1 -25/+12	$(V+) - 0.75$ $(V+) - 0.75$ 0.2 0.2 $(V+) - 0.75$ $(V+) - 0.75$ 0.1 0.1 -25/+12		V V V V V V V V mA
POWER SUPPLY Specified Voltage Range Minimum Operating Voltage Quiescent Current $T_A = -40^\circ\text{C}$ to 85°C	V_S I_Q $T_A = -40^\circ\text{C}$ to 85°C $I_O = 0$ $I_O = 0$	+2.6	+2.2 50	+36 60 70	V V μA μA
TEMPERATURE RANGE Specified Range Operating Range Storage Range Thermal Resistance SOT-23-5 Surface-Mount SO-8 Surface-Mount 8-Pin DIP	θ_{JA}	-40 -55 -65		85 125 150	$^\circ\text{C}$ $^\circ\text{C}$ $^\circ\text{C}$ $^\circ\text{C}/W$ $^\circ\text{C}/W$ $^\circ\text{C}/W$

NOTE: (1) $V_S = +15V$.

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SPECIFICATIONS: $V_S = +2.6V$ to $+36V$

Boldface limits apply over the specified temperature range, $T_A = -40^{\circ}C$ to $+85^{\circ}C$

At $T_A = +25^{\circ}C$, $R_L = 20k\Omega$ connected to ground, unless otherwise noted.

PARAMETER	CONDITION	OPA2244EA, PA, UA			UNITS
		MIN	TYP ⁽¹⁾	MAX	
OFFSET VOLTAGE Input Offset Voltage $T_A = -40^{\circ}C$ to $85^{\circ}C$ vs Temperature vs Power Supply $T_A = -40^{\circ}C$ to $85^{\circ}C$ Channel Separation	V_{OS} $V_S = \pm 7.5V, V_{CM} = 0$ dV_{OS}/dT $PSRR$ $T_A = -40^{\circ}C$ to $85^{\circ}C$ $V_S = +2.6V$ to $+36V$ $V_S = +2.6V$ to $+36V$		± 0.7 ± 4 5 140	± 1.5 ± 2 50 50	mV mV $\mu V/^{\circ}C$ $\mu V/V$ $\mu V/V$ dB
INPUT BIAS CURRENT Input Bias Current Input Offset Current	I_B I_{OS} $V_{CM} = V_S/2$ $V_{CM} = V_S/2$		-10 ± 1	-25 ± 10	nA nA
NOISE Input Voltage Noise, $f = 0.1kHz$ to $10kHz$ Input Voltage Noise Density, $f = 1kHz$ Current Noise Density, $f = 1kHz$	e_n i_n		0.4 22 40		$\mu Vp-p$ nV/\sqrt{Hz} fA/\sqrt{Hz}
INPUT VOLTAGE RANGE Common-Mode Voltage Range Common-Mode Rejection $T_A = -40^{\circ}C$ to $85^{\circ}C$	V_{CM} CMRR $V_S = \pm 18V, V_{CM} = -18V$ to $+17.1V$ $V_S = \pm 18V, V_{CM} = -18V$ to $+17.1V$	0 72 72	98	$(V+) - 0.9$	V dB dB
INPUT IMPEDANCE Differential Common-Mode			$10^6 \parallel 2$ $10^9 \parallel 2$		$\Omega \parallel pF$ $\Omega \parallel pF$
OPEN-LOOP GAIN Open-Loop Voltage Gain $T_A = -40^{\circ}C$ to $85^{\circ}C$	A_{OL} $V_O = 0.5V$ to $(V+) - 0.9$ $V_O = 0.5V$ to $(V+) - 0.9$	86 86	106		dB dB
FREQUENCY RESPONSE Gain-Bandwidth Product Slew Rate Settling Time 0.01% Overload Recovery Time	GBW SR $G = 1$ 10V Step $V_{IN} \cdot Gain = V_S$		430 $-0.1/+0.16$ 150 8		kHz V/ μs μs μs
OUTPUT Voltage Output, Positive $T_A = -40^{\circ}C$ to $85^{\circ}C$ Voltage Output, Negative $T_A = -40^{\circ}C$ to $85^{\circ}C$ Voltage Output, Positive $T_A = -40^{\circ}C$ to $85^{\circ}C$ Voltage Output, Negative $T_A = -40^{\circ}C$ to $85^{\circ}C$ Short-Circuit Current Capacitive Load Drive	V_O I_{SC} C_{LOAD} $A_{OL} \geq 80dB, R_L = 20k\Omega$ to $V_S/2$ $A_{OL} \geq 80dB, R_L = 20k\Omega$ to $V_S/2$ $A_{OL} \geq 80dB, R_L = 20k\Omega$ to $V_S/2$ $A_{OL} \geq 80dB, R_L = 20k\Omega$ to $V_S/2$ $A_{OL} \geq 80dB, R_L = 20k\Omega$ to Ground $A_{OL} \geq 80dB, R_L = 20k\Omega$ to Ground $A_{OL} \geq 80dB, R_L = 20k\Omega$ to Ground $A_{OL} \geq 80dB, R_L = 20k\Omega$ to Ground $A_{OL} \geq 80dB, R_L = 20k\Omega$ to Ground $A_{OL} \geq 80dB, R_L = 20k\Omega$ to Ground See Typical Curve	$(V+) - 0.9$ $(V+) - 0.9$ 0.5 0.5 0.1 0.1 $-25/+12$	$(V+) - 0.75$ $(V+) - 0.75$ 0.2 0.2 $(V+) - 0.75$ $(V+) - 0.75$ 0.1 0.1		V V V V V V V V mA
POWER SUPPLY Specified Voltage Range Minimum Operating Voltage Quiescent Current (per amplifier) $T_A = -40^{\circ}C$ to $85^{\circ}C$	V_S I_Q $T_A = -40^{\circ}C$ to $85^{\circ}C$ $I_O = 0$ $I_O = 0$	+2.6	+2.2 40	+36 50 63	V V μA μA
TEMPERATURE RANGE Specified Range Operating Range Storage Range Thermal Resistance MSOP-8 Surface-Mount SO-8 Surface-Mount 8-Pin DIP	θ_{JA}	-40 -55 -65		85 125 150	$^{\circ}C$ $^{\circ}C$ $^{\circ}C$ $^{\circ}C/W$ $^{\circ}C/W$ $^{\circ}C/W$

NOTE: (1) $V_S = +15V$.

SPECIFICATIONS: $V_S = +2.6V$ to $+36V$

Boldface limits apply over the specified temperature range, $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$

At $T_A = +25^\circ\text{C}$, $R_L = 20\text{k}\Omega$ connected to ground, unless otherwise noted.

PARAMETER	CONDITION	OPA4244EA			UNITS
		MIN	TYP ⁽¹⁾	MAX	
OFFSET VOLTAGE Input Offset Voltage $T_A = -40^\circ\text{C}$ to 85°C vs Temperature vs Power Supply $T_A = -40^\circ\text{C}$ to 85°C Channel Separation	V_{OS} $V_S = \pm 7.5V, V_{CM} = 0$ dV_{OS}/dT $PSRR$ $T_A = -40^\circ\text{C}$ to 85°C $V_S = +2.6V$ to $+36V$ $V_S = +2.6V$ to $+36V$		± 0.7 ± 4 5 140	± 1.5 ± 2 50 50	mV mV $\mu\text{V}/^\circ\text{C}$ $\mu\text{V}/V$ $\mu\text{V}/V$ dB
INPUT BIAS CURRENT Input Bias Current Input Offset Current	I_B I_{OS} $V_{CM} = V_S/2$ $V_{CM} = V_S/2$		-10 ± 1	-25 ± 10	nA nA
NOISE Input Voltage Noise, $f = 0.1\text{kHz}$ to 10kHz Input Voltage Noise Density, $f = 1\text{kHz}$ Current Noise Density, $f = 1\text{kHz}$	e_n i_n		0.4 22 40		$\mu\text{Vp-p}$ $\text{nV}/\sqrt{\text{Hz}}$ $\text{fA}/\sqrt{\text{Hz}}$
INPUT VOLTAGE RANGE Common-Mode Voltage Range Common-Mode Rejection $T_A = -40^\circ\text{C}$ to 85°C	V_{CM} CMRR $V_S = \pm 18V, V_{CM} = -18V$ to $+17.1V$ $V_S = \pm 18V, V_{CM} = -18V$ to $+17.1V$	0 82 82		$(V+) - 0.9$ 104	V dB dB
INPUT IMPEDANCE Differential Common-Mode			$10^6 \parallel 2$ $10^9 \parallel 2$		$\Omega \parallel \text{pF}$ $\Omega \parallel \text{pF}$
OPEN-LOOP GAIN Open-Loop Voltage Gain $T_A = -40^\circ\text{C}$ to 85°C	A_{OL} $V_O = 0.5V$ to $(V+) - 0.9$ $V_O = 0.5V$ to $(V+) - 0.9$	86 86	106		dB dB
FREQUENCY RESPONSE Gain-Bandwidth Product Slew Rate Settling Time 0.01% Overload Recovery Time	GBW SR $G = 1$ 10V Step $V_{IN} \cdot \text{Gain} = V_S$		430 $-0.1/+0.16$ 150 8		kHz $\text{V}/\mu\text{s}$ μs μs
OUTPUT Voltage Output, Positive $T_A = -40^\circ\text{C}$ to 85°C Voltage Output, Negative $T_A = -40^\circ\text{C}$ to 85°C Voltage Output, Positive $T_A = -40^\circ\text{C}$ to 85°C Voltage Output, Negative $T_A = -40^\circ\text{C}$ to 85°C Short-Circuit Current Capacitive Load Drive	V_O I_{SC} C_{LOAD} $A_{OL} \geq 80\text{dB}, R_L = 20\text{k}\Omega$ to $V_S/2$ $A_{OL} \geq 80\text{dB}, R_L = 20\text{k}\Omega$ to $V_S/2$ $A_{OL} \geq 80\text{dB}, R_L = 20\text{k}\Omega$ to $V_S/2$ $A_{OL} \geq 80\text{dB}, R_L = 20\text{k}\Omega$ to Ground $A_{OL} \geq 80\text{dB}, R_L = 20\text{k}\Omega$ to Ground $A_{OL} \geq 80\text{dB}, R_L = 20\text{k}\Omega$ to Ground $A_{OL} \geq 80\text{dB}, R_L = 20\text{k}\Omega$ to Ground $A_{OL} \geq 80\text{dB}, R_L = 20\text{k}\Omega$ to Ground $A_{OL} \geq 80\text{dB}, R_L = 20\text{k}\Omega$ to Ground See Typical Curve	$(V+) - 0.9$ $(V+) - 0.9$ 0.5 0.5 0.1 0.1 $-25/+12$	$(V+) - 0.75$ $(V+) - 0.75$ 0.2 0.2 $(V+) - 0.75$ $(V+) - 0.75$ 0.1 0.1		V V V V V V V V mA
POWER SUPPLY Specified Voltage Range Minimum Operating Voltage Quiescent Current (per amplifier) $T_A = -40^\circ\text{C}$ to 85°C	V_S I_Q $T_A = -40^\circ\text{C}$ to 85°C $I_O = 0$ $I_O = 0$	+2.6	+2.2 40	+36 60 70	V V μA μA
TEMPERATURE RANGE Specified Range Operating Range Storage Range Thermal Resistance TSSOP-14 Surface Mount	θ_{JA}	-40 -55 -65		85 125 150	$^\circ\text{C}$ $^\circ\text{C}$ $^\circ\text{C}$ $^\circ\text{C}/W$

NOTE: (1) $V_S = +15V$.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Supply Voltage, V+ to V-	36V
Input Voltage Range ⁽²⁾	(V-) – 0.3V to (V+) + 0.3V
Input Current ⁽²⁾	10mA
Output Short-Circuit ⁽³⁾	Continuous
Operating Temperature	–55°C to +125°C
Storage Temperature	–65°C to +150°C
Junction Temperature	150°C
Lead Temperature (soldering, 10s)	300°C
ESD Capability	2000V

NOTES: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. (2) Inputs are diode-clamped to the supply rails and should be current-limited to 10mA or less if input voltages can exceed rails by more than 0.3V. (3) Short-circuit to ground, one amplifier per package.



ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

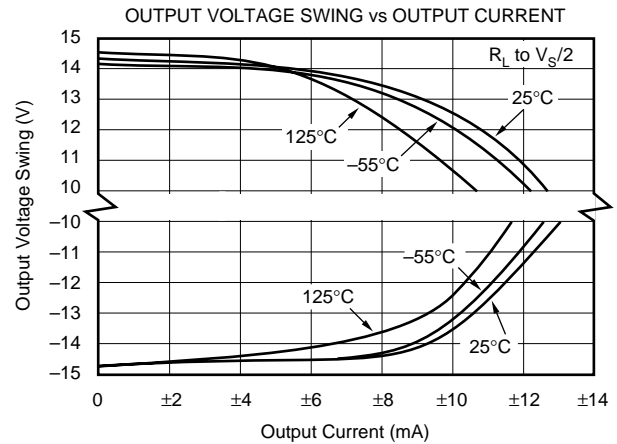
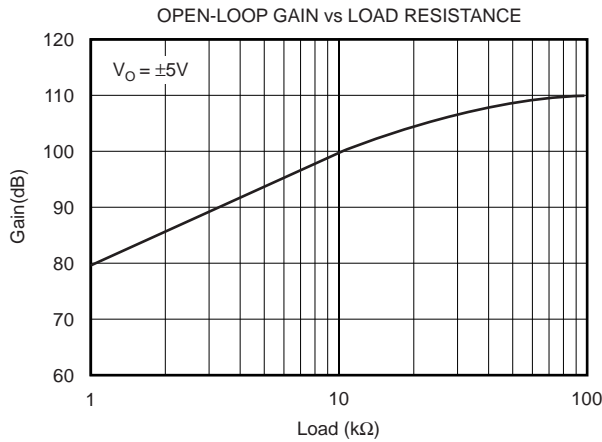
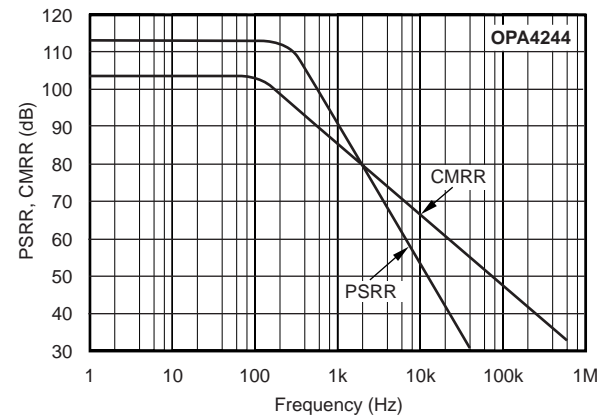
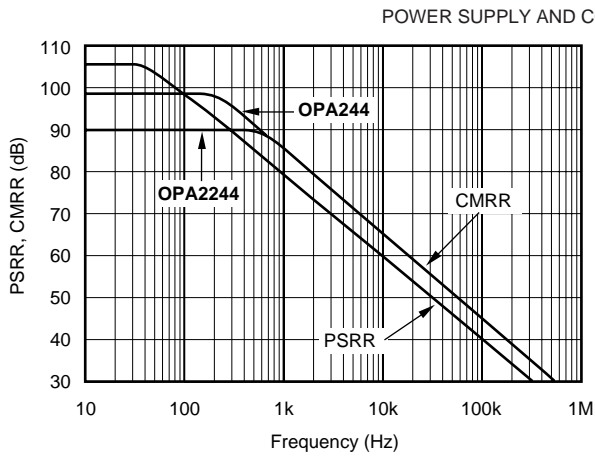
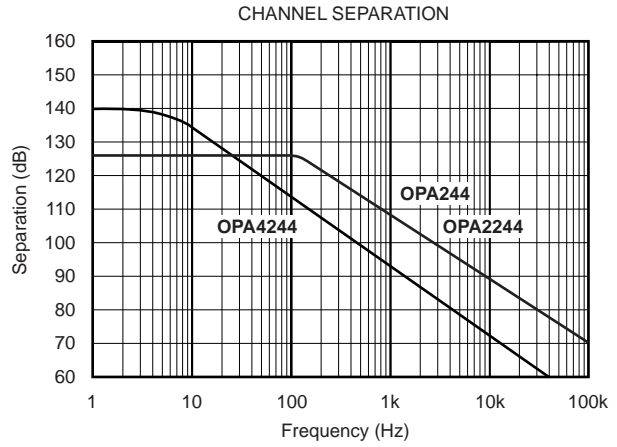
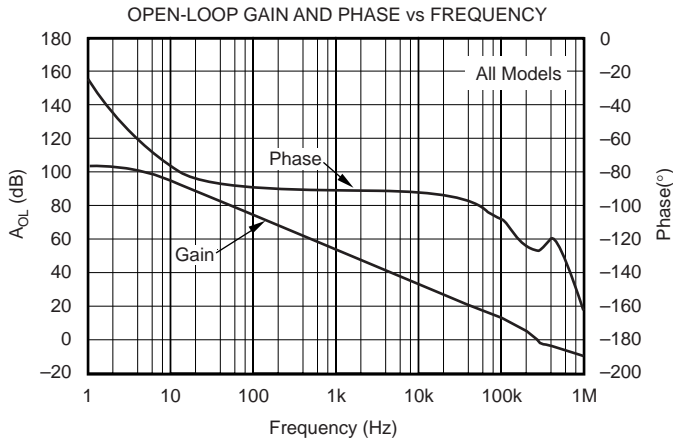
PACKAGE/ORDERING INFORMATION

PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER ⁽¹⁾	TRANSPORT MEDIA
Single						
OPA244NA "	SOT-23-5 Surface-Mount "	331 "	–40°C to +85°C "	A44 "	OPA244NA/250	Tape and Reel
OPA244PA OPA244UA "	8-Pin DIP SO-8 Surface-Mount "	006 182 "	–40°C to +85°C –40°C to +85°C "	OPA244PA OPA244UA "	OPA244NA/3K OPA244PA OPA244UA OPA244UA/2K5	Tape and Reel Rails Rails Tape and Reel
Dual						
OPA2244EA "	MSOP-8 Surface-Mount "	337 "	–40°C to +85°C "	A44 "	OPA2244EA/250	Tape and Reel
OPA2244PA OPA2244UA "	8-Pin DIP SO-8 Surface-Mount "	006 182 "	–40°C to +85°C –40°C to +85°C "	OPA2244PA OPA2244UA "	OPA2244EA/2K5 OPA2244PA OPA2244UA OPA2244UA/2K5	Tape and Reel Rails Rails Tape and Reel
Quad						
OPA4244EA "	TSSOP-14 Surface-Mount "	357 "	–40°C to +85°C "	OPA4244EA "	OPA4244EA/250 OPA4244EA/2K5	Tape and Reel Tape and Reel

NOTE: (1) Products followed by a slash (/) are only available in Tape and Reel in the quantities indicated (e.g., /250 indicates 250 devices per reel). Ordering 3000 pieces of "OPA244NA/3K" will get a single 3000 piece Tape and Reel.

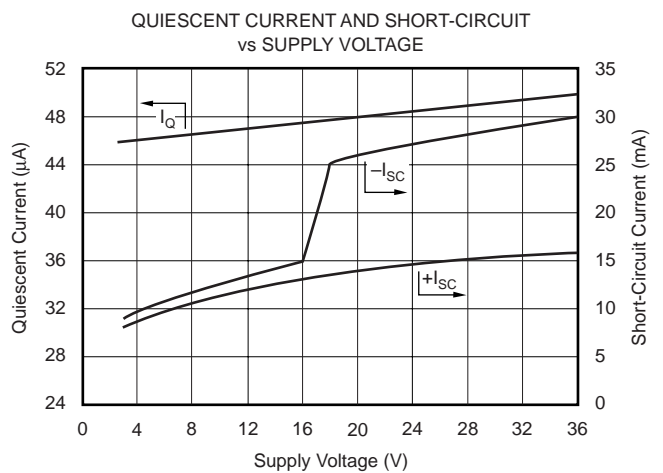
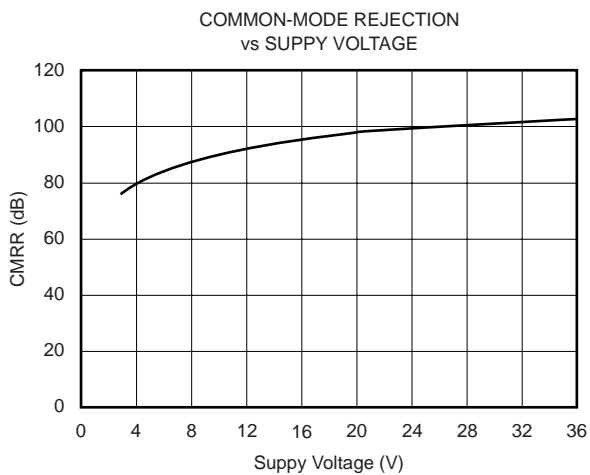
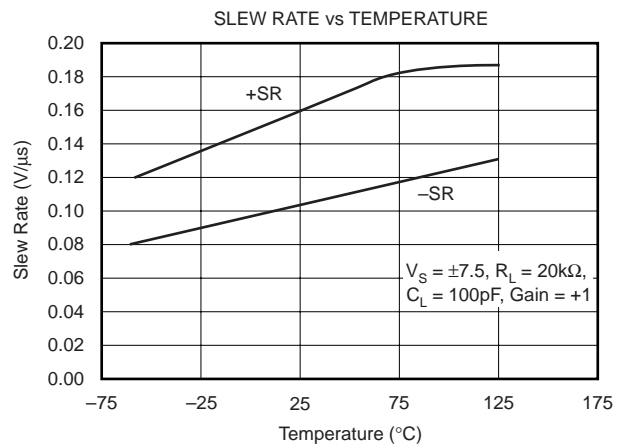
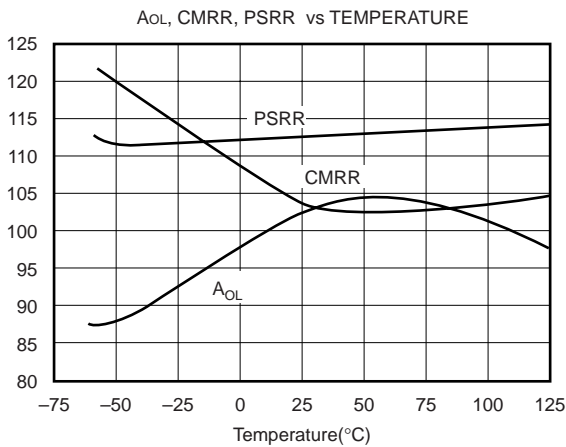
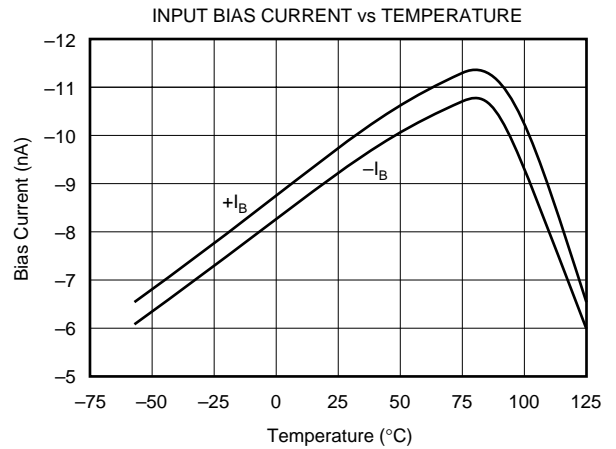
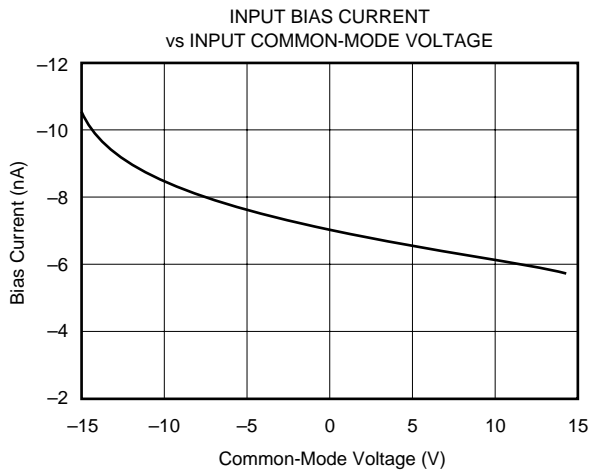
TYPICAL PERFORMANCE CURVES

At $T_A = 25^\circ\text{C}$, $V_S = +15\text{V}$, and $R_L = 20\text{k}\Omega$ connected to Ground, unless otherwise noted.



TYPICAL PERFORMANCE CURVES (Cont.)

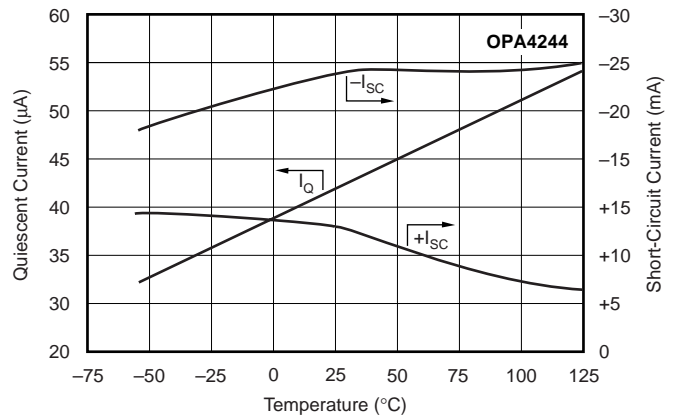
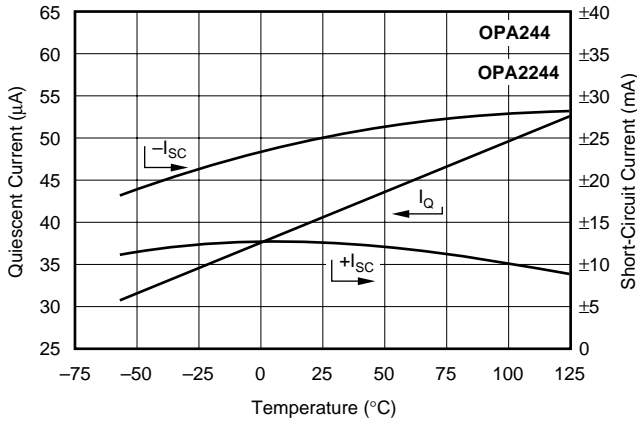
At $T_A = 25^\circ\text{C}$, $V_S = +15\text{V}$, and $R_L = 20\text{k}\Omega$ connected to Ground, unless otherwise noted.



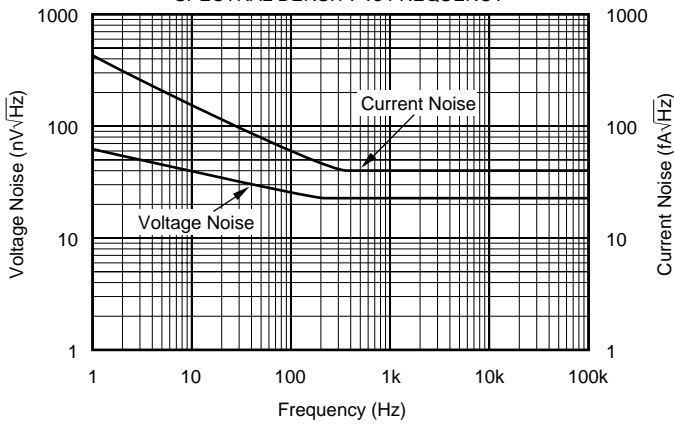
TYPICAL PERFORMANCE CURVES (Cont.)

At $T_A = 25^\circ\text{C}$, $V_S = +15\text{V}$, and $R_L = 20\text{k}\Omega$ connected to Ground, unless otherwise noted.

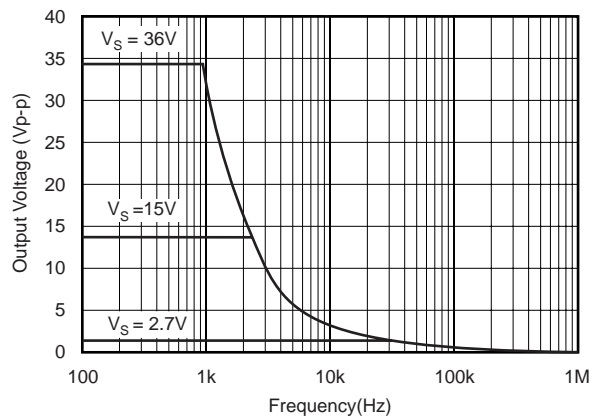
QUIESCENT AND SHORT-CIRCUIT CURRENT vs TEMPERATURE



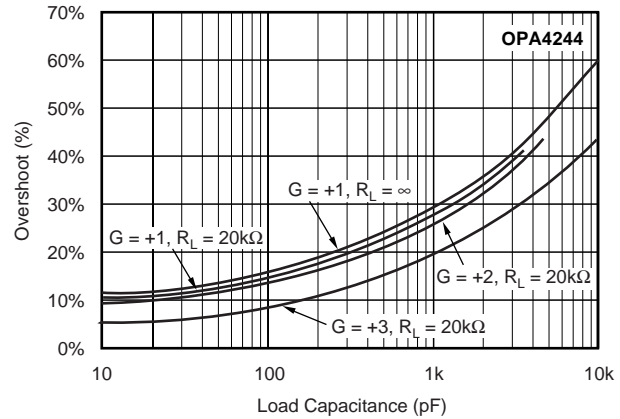
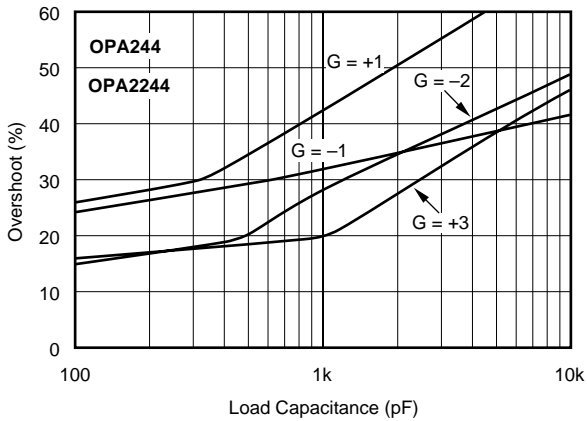
INPUT VOLTAGE AND CURRENT NOISE SPECTRAL DENSITY vs FREQUENCY



MAXIMUM OUTPUT VOLTAGE vs FREQUENCY



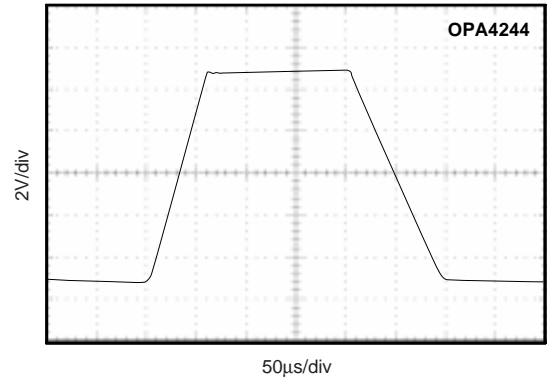
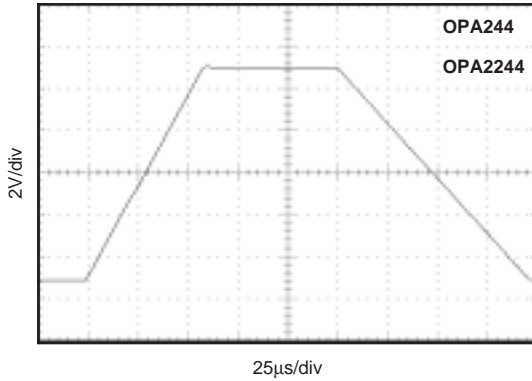
SMALL SIGNAL OVERSHOOT vs LOAD CAPACITANCE



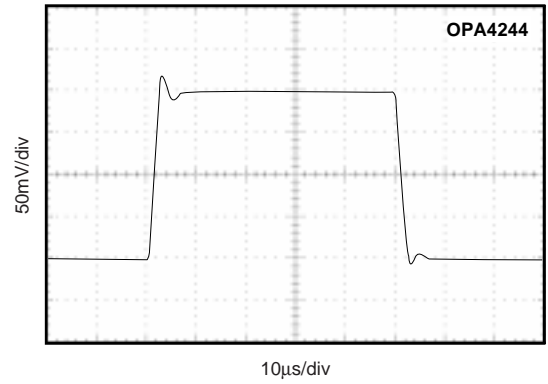
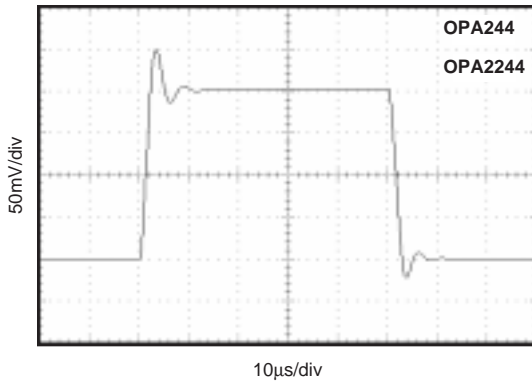
TYPICAL PERFORMANCE CURVES (Cont.)

At $T_A = 25^\circ\text{C}$, $V_S = +15\text{V}$, and $R_L = 20\text{k}\Omega$ connected to Ground, unless otherwise noted.

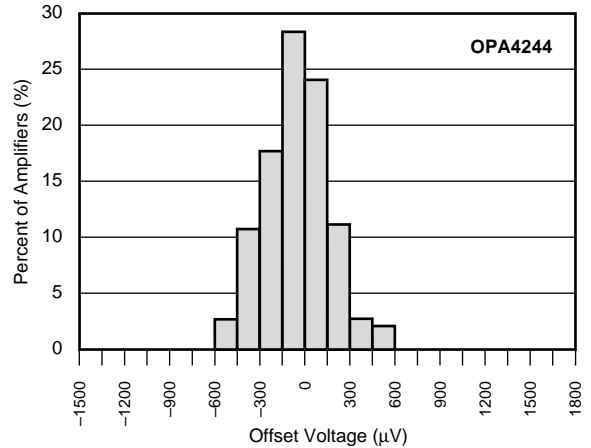
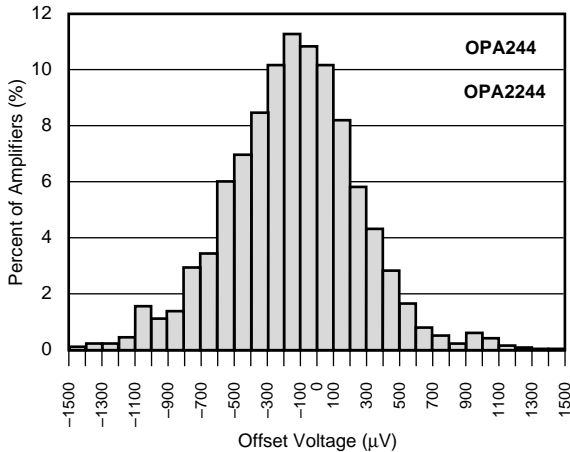
LARGE-SIGNAL STEP RESPONSE, $G = 1$, $C_L = 100\text{pF}$



SMALL-SIGNAL STEP RESPONSE, $G = 1$, $C_L = 100\text{pF}$



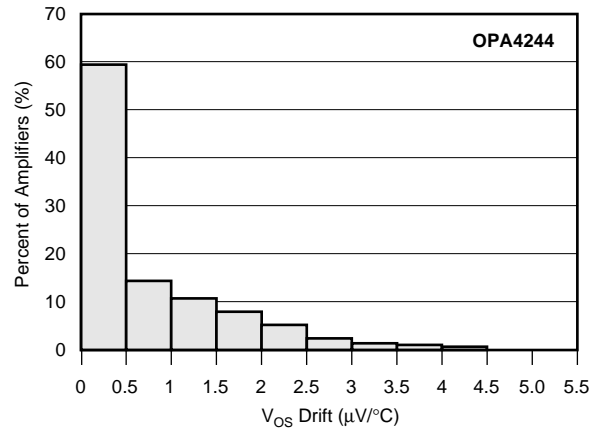
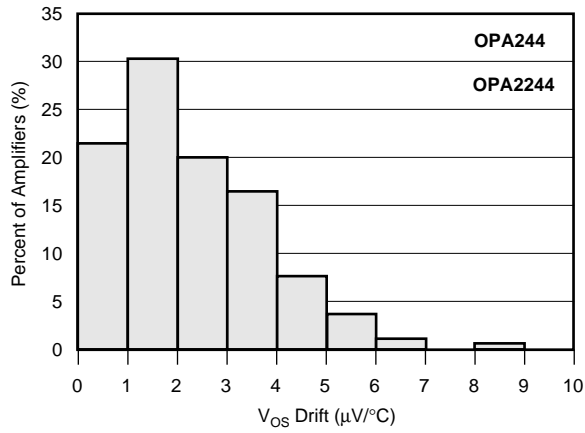
OFFSET VOLTAGE PRODUCTION DISTRIBUTION



TYPICAL PERFORMANCE CURVES (Cont.)

At $T_A = 25^\circ\text{C}$, $V_S = +15\text{V}$, and $R_L = 20\text{k}\Omega$ connected to Ground, unless otherwise noted.

OFFSET VOLTAGE PRODUCTION DISTRIBUTION



APPLICATIONS INFORMATION

The OPA244 is unity-gain stable and suitable for a wide range of general purpose applications. Power supply pins should be bypassed with 0.01µF ceramic capacitors.

OPERATING VOLTAGE

The OPA244 can operate from single supply (+2.2V to +36V) or dual supplies (±1.1 to ±18V) with excellent performance. Unlike most op amps which are specified at only one supply voltage, the OPA244 is specified for real world applications; a single set of specifications applies throughout the +2.6V to +36V (±1.3 to ±18V) supply range.

This allows a designer to have the same assured performance at any supply voltage within this range. In addition, many key parameters are guaranteed over the specified temperature range, -40°C to +85°C. Most behavior remains unchanged throughout the full operating voltage range. Parameters which vary significantly with operating voltage or temperature are shown in typical performance curves.

Useful information on solder pad design for printed circuit boards can be found in Burr-Brown's Application Bulletin AB-132B, "Solder Pad Recommendations for Surface-Mount Devices," easily found at Burr-Brown's web site (<http://www.burr-brown.com>).

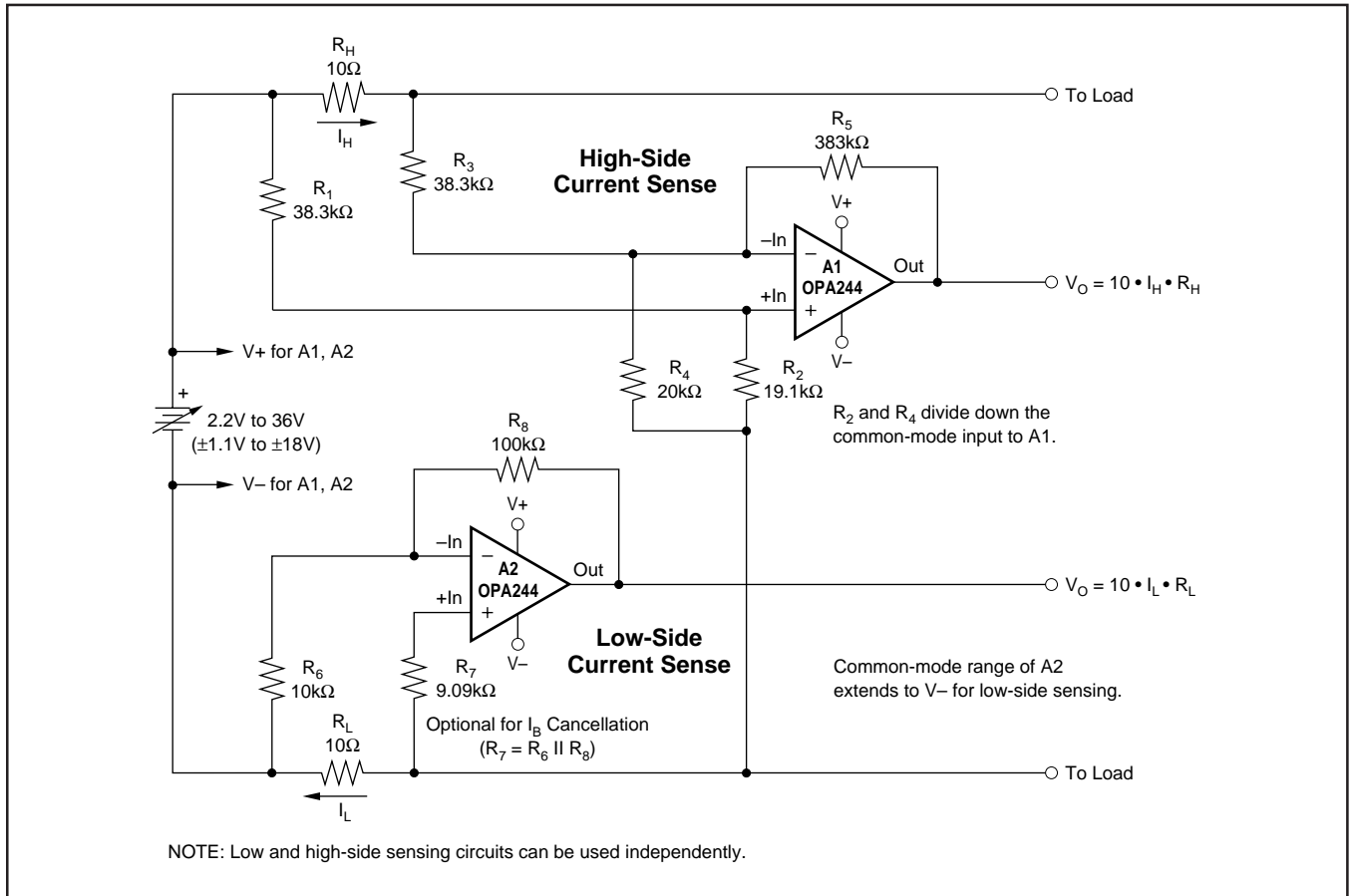


FIGURE 1. Low and High-Side Battery Current Sensing.

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
OPA2244EA/250	ACTIVE	MSOP	DGK	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA2244EA/250G4	ACTIVE	MSOP	DGK	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA2244EA/2K5	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA2244EA/2K5G4	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA2244PA	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA2244PAG4	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA2244UA	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2244UA/2K5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2244UA/2K5G4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2244UAG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA244NA/250	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA244NA/250G4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA244NA/3K	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA244NA/3KG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA244PA	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA244PAG4	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA244UA	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA244UA/2K5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA244UA/2K5E4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA244UAE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4244EA/250	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4244EA/250E4	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4244EA/2K5	ACTIVE	TSSOP	PW	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4244EA/2K5E4	ACTIVE	TSSOP	PW	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
OPA2244EA/250	MSOP	DGK	8	250	180.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
OPA2244EA/2K5	MSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
OPA2244UA/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA244NA/250	SOT-23	DBV	5	250	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
OPA244NA/3K	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
OPA244UA/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA4244EA/250	TSSOP	PW	14	250	180.0	12.4	7.0	5.6	1.6	8.0	12.0	Q1
OPA4244EA/2K5	TSSOP	PW	14	2500	330.0	12.4	7.0	5.6	1.6	8.0	12.0	Q1

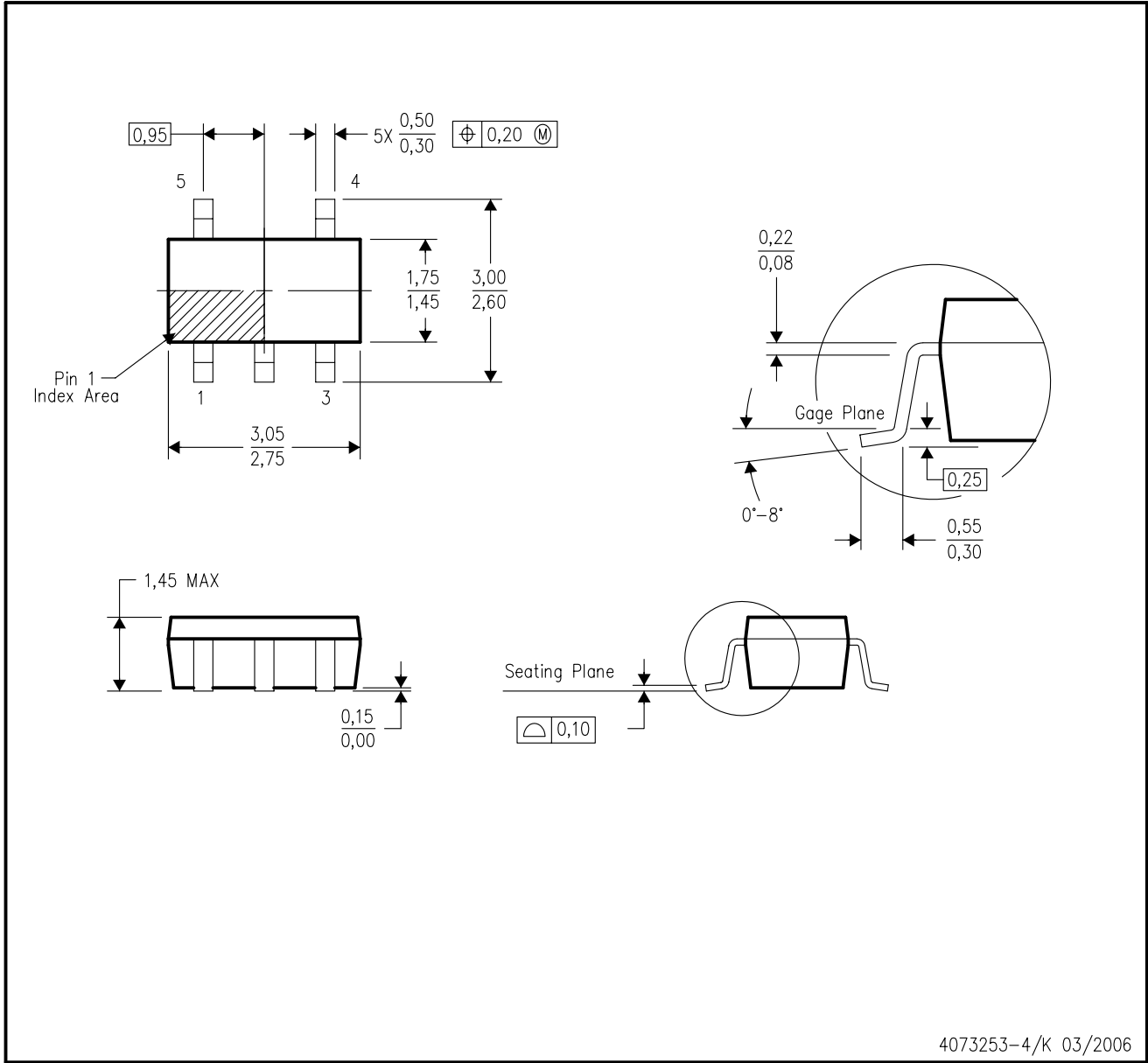
TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
OPA2244EA/250	MSOP	DGK	8	250	190.5	212.7	31.8
OPA2244EA/2K5	MSOP	DGK	8	2500	346.0	346.0	29.0
OPA2244UA/2K5	SOIC	D	8	2500	346.0	346.0	29.0
OPA244NA/250	SOT-23	DBV	5	250	190.5	212.7	31.8
OPA244NA/3K	SOT-23	DBV	5	3000	190.5	212.7	31.8
OPA244UA/2K5	SOIC	D	8	2500	346.0	346.0	29.0
OPA4244EA/250	TSSOP	PW	14	250	190.5	212.7	31.8
OPA4244EA/2K5	TSSOP	PW	14	2500	346.0	346.0	29.0

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-178 Variation AA.

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



4073329/E 05/06

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
 - E. Falls within JEDEC MO-187 variation AA, except interlead flash.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



4040082/D 05/98

- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm



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